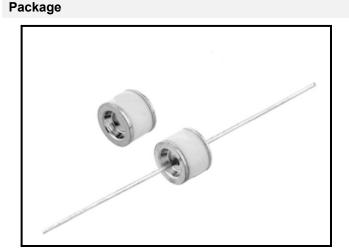


### **Gas Discharge Tube**

#### **Features**

- · High insulation resistance
- Low capacitance (≤1.5pF)
- 10KA 8/20µs maximum surge current capacity in accordance with IEC61000-4-5
- 10KV 10/700µs maximum surge rating in accordance with ITU-TK.21
- · Surface mounted gas arrester
- · Micro-Gap Design
- Size 8.0×6.0
- Storage and operating temperature: -40°C ~ +85°C
- Meets MSL level 1, per J-STD-020



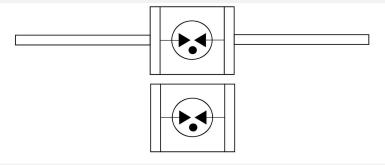
#### **Applications**

- Communication equipment
- · CATV equipment
- · Test equipment
- · Data lines
- · Power supplies
- Telecom SLIC protection

### **Applications**

- · Broadband equipment
- ADSL equipment, including ADSL2+
- · XDSL equipment
- · Satellite and CATV equipment
- · General telecom equipment

### **Schematic & PIN Configuration**



#### **Ordering information**

Order code	Package	Base qty	Delivery mode
BA2R2D8-xxx	8.0×6.0-W	500	Bulk
BS2R2D8-xxxB	8.0×6.0	500	Bulk

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**Gas Discharge Tube** 

Absolute Maximum Ratings (T<sub>A</sub>=+25°C, unless otherwise noted)

Part Number		DC Sparkover Voltage	Maximum Impulse Spark-over Voltage	Ins	nimum ulation istance	Max. Capaci- tance	Impulse withstanding Voltage Capacity	Nominal Impulse Discharge Current
		100V/S	1KV/us	(60)	Test DC Voltage	1MHZ	10/700us ±5times	8/20us ±5times
		(V)	(V)	(GΩ)	(V)	(pF)	(KV)	(KA)
BA2R2D8-75B	BS2R2D8-75B	75±20%	700	1	25	1	10	10
BA2R2D8-90B	BS2R2D8-90B	90±20%	700	1	50	1	10	10
BA2R2D8-150B	BS2R2D8-150B	150±20%	700	1	100	1	10	10
BA2R2D8-230B	BS2R2D8-230B	230±20%	700	1	100	1	10	10
BA2R2D8-300B	BS2R2D8-300B	300±20%	900	1	100	1	10	10
BA2R2D8-350B	BS2R2D8-350B	350±20%	900	1	100	1	10	10
BA2R2D8-470B	BS2R2D8-470B	470±20%	1100	1	250	1	10	10
BA2R2D8-600B	BS2R2D8-600B	600±20%	1500	1	250	1	10	10
BS2R2D8-800B	BS2R2D8-800B	800±20%	1700	1	250	1	10	10
BA2R2D8-1000B	BS2R2D8-1000B	1000±20%	1800	1	500	1.5	10	10
BA2R2D8-1500B	BS2R2D8-1500B	1500±20%	2500	1	500	1.5	10	10
BA2R2D8-2000	BS2R2D8-2000	2000±20%	2000	1	500	1.5	10	5
BA2R2D8-3000	BS2R2D8-3000	3000±20%	3000	1	500	1.5	10	5
BS2R2D8-3600	BS2R2D8-3600	3600±20%	4600	1	500	1.5	10	5

#### **Electrical Parameters**

Items	Test Condition/Description	Requirement
DC Spark-over	The voltage is measured with voltage ramp dv/dt=100V/s.	
Voltage	The voltage is measured with voltage ramp dv/dt-100 v/s.	
Maximum Impulse	The maximum impulse spark-over voltage is measured with voltage ramp	
Spark-over Voltage	dv/dt=1000V/us.	
Insulation	Insulation The registered of got tube shall be managined between two started as	
Resistance	The resistance of gas tube shall be measured between two electrodes.	To meet
Capacitance	The capacitance of gas tube shall be measured between two electrodes.	the specified
Сараспансе	Test frequency: 1MHz	value
Impulse	Maximum 8/20µs surge current that can be applied between two electrodes,	
Discharge	5 positive and 5 negative surges, with 3 minutes interval time, without causing	
Current	the DC spark-over voltage to change more than 25% from its initial value.	
Impulse	The maximum 10/700µs surge that can be applied to the Gas Tube, 5	
Withstanding	positive and 5 negative surges, with 1 minute interval time, without causing	
Voltage	the DC spark-over voltage to change more than 25% from its initial value.	

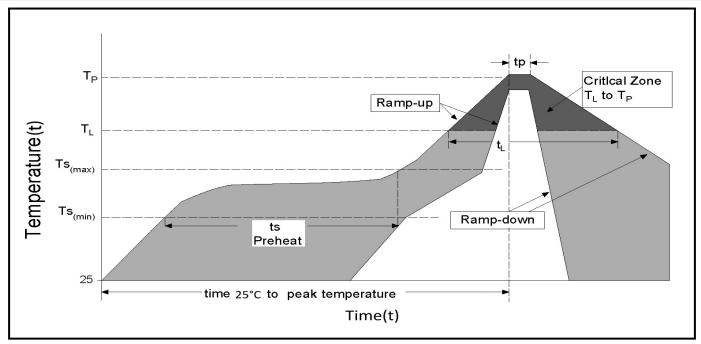
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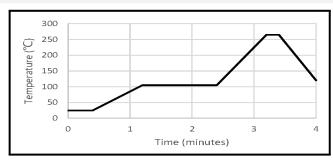
### **Gas Discharge Tube**

### **Soldering Parameters**



Reflow	Lead-free assembly		
	- Temperature Min (T <sub>S</sub> (min))	150°C	
Pre Heat	- Temperature Max (T <sub>S</sub> (max))	200°C	
	- Time (min to max) (t <sub>S</sub> )	60 - 180 secs	
Average ramp up rate (L	Average ramp up rate (Liquidus Temp (T <sub>L</sub> ) to peak)		
T <sub>S</sub> (max) to T <sub>L</sub>	T <sub>S</sub> (max) to T <sub>L</sub> - Ramp-up Rate		
Defless	- Temperature (T <sub>L</sub> ) (Liquidus)	217°C	
Reflow	- Time (t <sub>L</sub> )	60 -150 secs	
Peak Temp	Peak Temperature (T <sub>P</sub> )		
Time within 5°C of actu	Time within 5°C of actual peak Temperature (t <sub>p</sub> )		
Ramp-d	6°C/second max		
Time 25°C to pe	8 minutes Max.		
Do no	260°C		

### **Soldering Parameters**



Wave Soldering	Lead-free assembly
Peak Temperature (T <sub>P</sub> )	260 <sup>+0/-5°C</sup>
Dipping Time (t)	10 Sec
Soldering	1 time

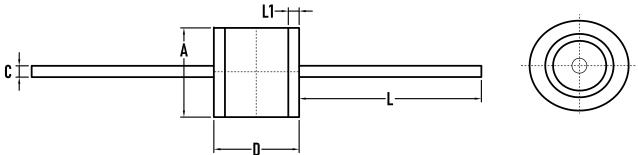
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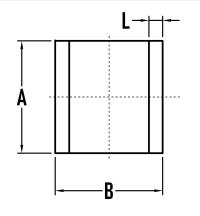
### **Gas Discharge Tube**

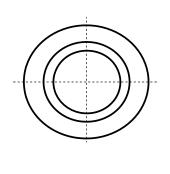
### Outline Drawing -8.0×6.0-W

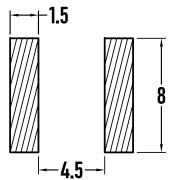


Dim	Millimeters			Inches		
Dim.	MIN.	NOW.	MAX.	MIN.	NOW.	MAX.
А	7.5	8	8.3	0.295	0.315	0.327
С	0.7	0.8	0.9	0.028	0.031	0.035
D	5.5	6	6.3	0.217	0.236	0.248
L	_	_	30	_	_	1.181
L1	0.4	0.5	0.6	0.016	0.02	0.024

### Outline Drawing -8.0×6.0







note:	
dimensions:	Millimeters

Dim	Millimeters			Inches		
Dilli.	Dim. MIN.		MAX.	MIN.	NOW.	MAX.
Α	7.5	8	8.3	0.295	0.315	0.327
В	5.5	6	6.3	0.217	0.236	0.248
L	0.4	0.5	0.6	0.016	0.02	0.024



